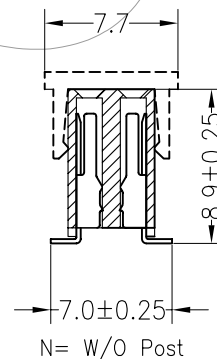
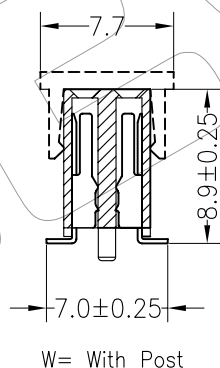
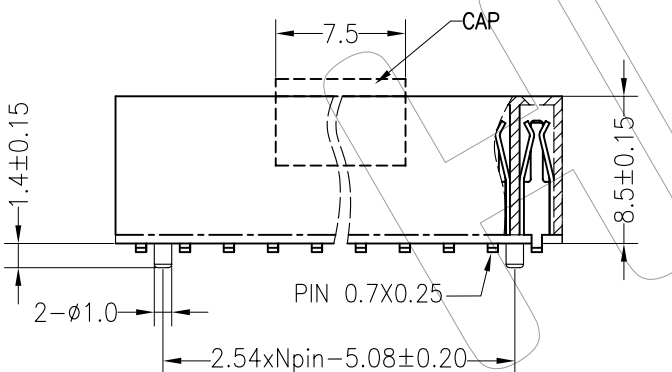
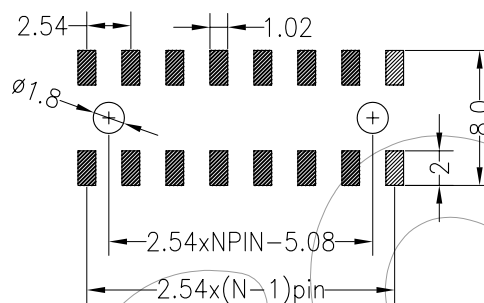
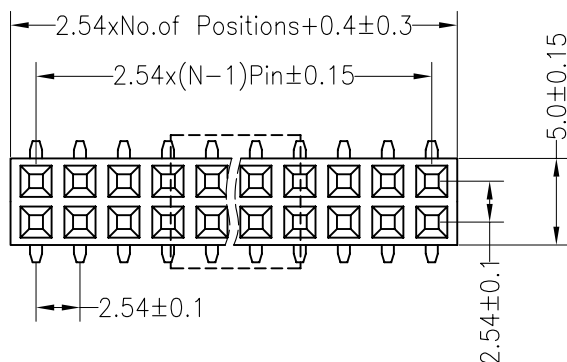


RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)



SPECIFICATIONS

Rated Current:3.0AMP

Contact Resistance:20m Ω Max

Withstand Voltage:1000V AC/DC

Insulation Resistance:1000M Ω Min

Operation Temperature:-40°C to +105°C

Contact Material:Brass

Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: PA6T

Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)

Ordering Information

HC-FH485 02 XX X X XX M U X 01

No.of
Pins
Per Row
2*40

Insulator Material
Option
A=BK-PA6T
B=BK-PA66
C=BK-PA6T
D=BK-PA46
F=BK-LCP

Post
W=With Post
N=W/O Post

Contact Plating
G0:Gold Flash
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar

OPERATION

X.X ± 0.30

X.XX ± 0.20

X.XXX ± 0.10

Angle $\pm 3^\circ$

DIM TOL

DRAW

Ayang

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

1

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-FH48502XXXXXXMUX01

TITLE:

2.54mm H8.5 Dual Row SMT
Female Header

A0

REV

DATE

MODIFICATION DESCRIPTION

CHANGE

1

2

3

4

5

6

7

8

9